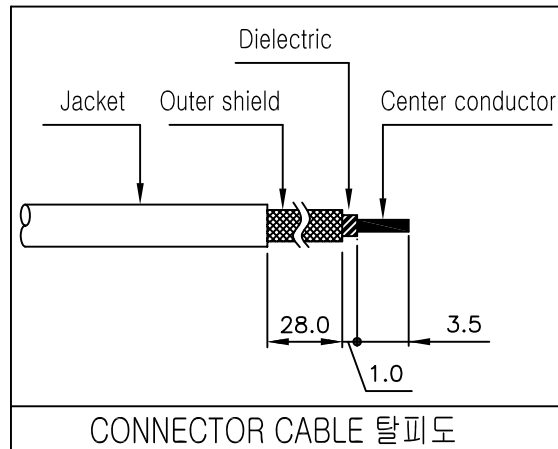
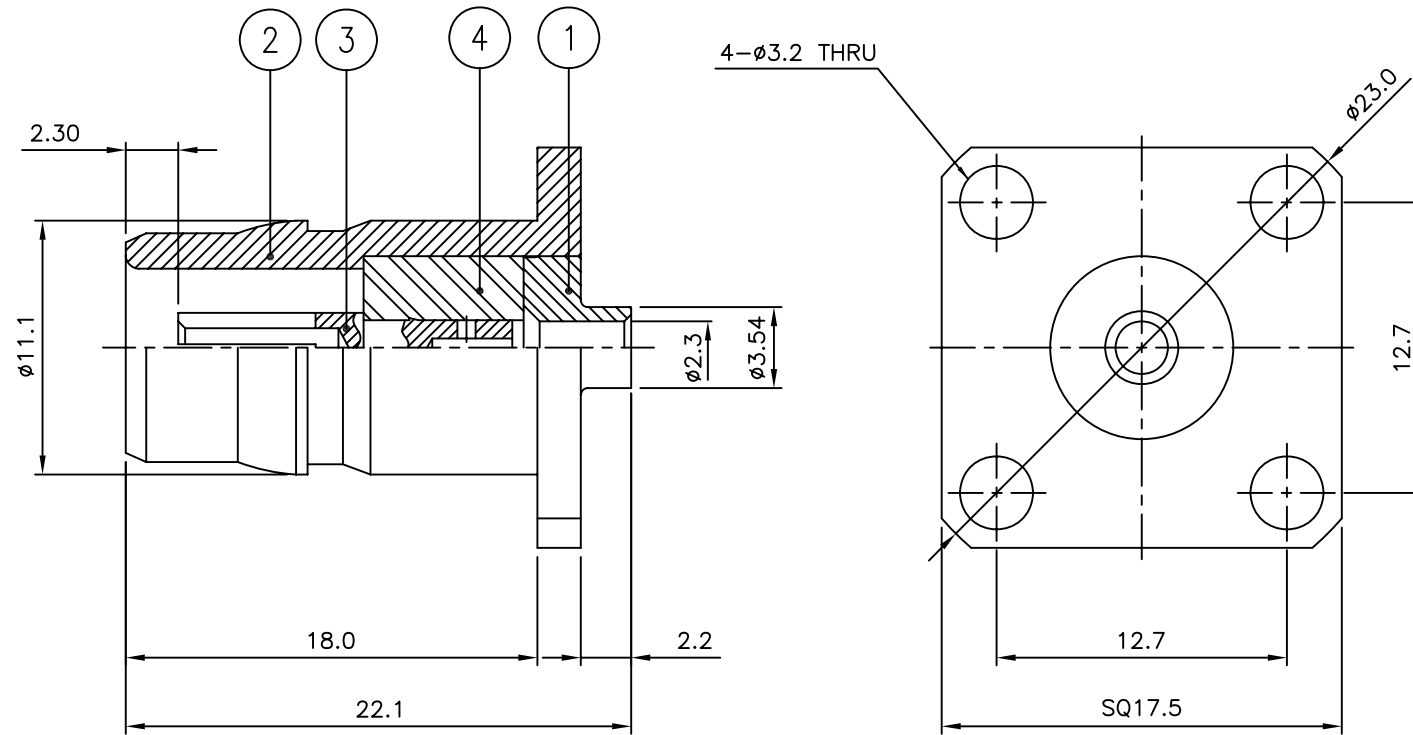


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	H.J.LEE	I.C.KIM	2015.12.22.



* 조립 방법

1. BODY(B)에 TEFLON을 끼워 넣는다.
2. TEFLON이 들어간 BODY (B)에 BODY(A)를 억지끼움 한다.
3. 조립된 BODY에 탈피 된 CABLE을 집어 넣는다.
4. CABLE 심선에 PIN을 납땜 한다.
5. JIG로 PIN을 TEFLON에 끼워 넣는다.

4	INSULATOR	1	TEFLON		DIN02711-N/1
3	CONTACT	1	BeCu C17300	Silver 3.0 μ m	DCT03618-5/1
2	BODY(B)	1	MBsBD C3604BD-F	SUCO 3.0 μ m	DBD04100-5/1
1	BODY(A)	1	MBsBD C3604BD-F	SUCO 3.0 μ m	DBD04099-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2015. 12. 22.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY	I.C.KIM	
MATERIAL		CHECKED BY	S.M.LEE	KJ COMTECH CO.,LTD. TITLE KQN50 CABLE JS-4H 85TP
		DRAWN BY	H.J.LEE	
FINISH		SCALE	3/1	A4 DWG NO. CN03541-7/1 REVISION I R SHEET 1 of 1
		UNIT	mm	